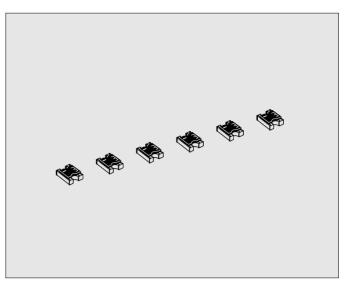
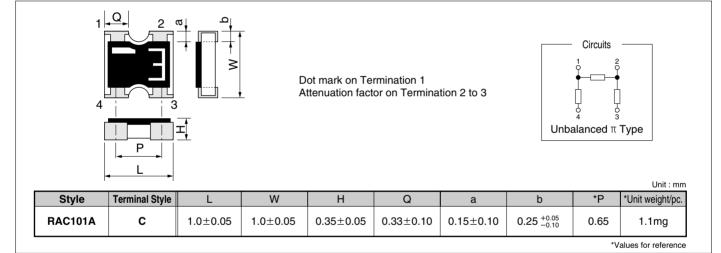
CHIP ATTENUATORS

Features

- 1. Suitable for use at DC and up to UHF band frequencies.
- 2. 75 ohm is available upon request.
- Replaceable three discrete resistors with one chip on attenuation circuits.



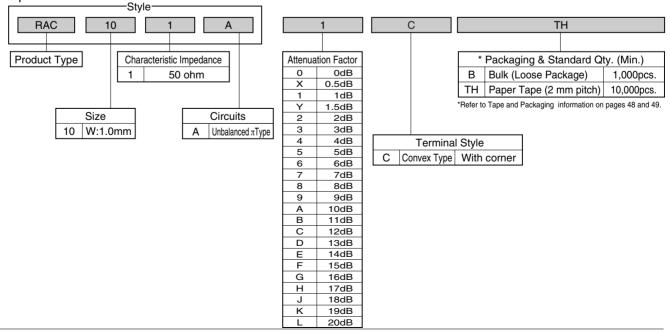
Dimensions and Circuits



RAC101A Chip Attenuators

Part Number Description

Example



RAC101A

CHIP ATTENUATORS

Ratings

Style	Characteristic Impedance	Attenuation symbol	on Factor dB	Tolerance on Attenuation Factor dB	Voltage Standing Wave Ratio	Frequency Range	Rated Input Power mW/package	Category Temperature Range °C
RAC101A	-	0	0	-	-	-	100	-40~+125
	50 ohm	Х	0.5	±0.1	1.1max.	DC ≤f ≤3GHz		
		1	1	±0.3				
		Y	1.5		- 1.2max.			
		2	2					
		3	3					
		4	4					
		5	5					
		6	6	±0.4				
		7	7					
		8	8					
		9	9					
		Α	10					
		В	11	±0.8				
		С	12					
		D	13					
		E	14	±1.0				
		F	15	±1.5				
		G	16					
		Н	17	±2.0				
		J	18					
		К	19					
		L	20	±2.5				

Note. The following information is available. 1. Test methods for Attenuation Factor and VSWR characteristics.

●Performance Characteristics JIS C 5201-1 : 1998

Description		Requirements		Test Methods		
Description	0.5~2dB	3dB~5dB	6dB~20dB	T est Metrious		
Characteristic impedance	50 ohm	$\begin{array}{c} \text{Measuring} \\ \text{Circuits} \\ R_2 \\ 4 \\ \end{array} \begin{array}{c} 1 \\ R_1 \\ R_2 \\ R_1 \\ R_2 \\ R_1 \\ R_2 \\ R_1 \\ R_2 \\ R_2 \\ R_1 \\ R_2 \\ R_2 \\ R_1 \\ R_2 \\ R_1 \\ R_2 \\ R_1 \\ R_1 \\ R_2 \\ R_1 \\ R_1$				
Insulation resistance	At least 100M ohm	ı		50Vd.c., 60s		
Solderability	In accordance with	n Clause 4.17.4.5	_	Clause 4.17 Dip into 235°C Solder bath for 2s.		
Resistance to soldering heat	Within ±0.1dB No major visible da	Within ±0.2dB amage.	Within ±0.3dB	Clause 4.18 Dip into 260°C Solder bath for 5s.		
Rapid change of temperature	Within ±0.1dB No major visible da	Within ±0.2dB amage.	Within ±0.3dB	Clause 4.19 5 cycles between -55° C and $+125^{\circ}$ C.		
Endurance at 85°C	Within ±0.1dB Within ±0.2dB		Within ±0.3dB	Clause 4.25.1 Rated input power, 1.5h"ON", 0.5h"OFF", 85°C, 1,000h.		
Bend strength of the face plating	Within ±0.1dB	Within ±0.2dB	Within ±0.3dB	Clause 4.33 Amount of bend : 3 mm		